Amplifier Transistors

PNP Silicon



ON Semiconductor[™]

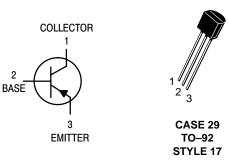
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MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|------------------|-------------------|----------------|
| Collector-Emitter Voltage BC556 BC557 BC558 | VCEO | -65 -45 -30 | Vdc |
| Collector-Base Voltage BC556 BC557 BC558 | V _{СВО} | 80 50 30 | Vdc |
| Emitter-Base Voltage | VEBO | -5.0 | Vdc |
| Collector Current – Continuous – Peak | IC ICM | -100 -200 | mAdc |
| Base Current – Peak | I _{BM} | -200 | mAdc |
| Total Device Dissipation @ T _A = 25°C Derate above 25°C | PD | 625 5.0 | mW mW/°C |
| Total Device Dissipation @ T _C = 25°C Derate above 25°C | PD | 1.5 12 | Watts mW/°C |
| Operating and Storage Junction Temperature Range | TJ, Tstg | –55 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Мах | Unit |
|--|------------------|------|------|
| Thermal Resistance, Junction to Ambient | $R_{	heta}$ JA | 200 | °C/W |
| Thermal Resistance, Junction to Case | R _{θJC} | 83.3 | °C/W |



ORDERING INFORMATION

| Device | Package | Shipping |
|-----------|---------|------------------|
| BC556B | TO-92 | 5000 Units/Box |
| BC556BRL1 | TO-92 | 2000/Tape & Reel |
| BC556BZL1 | TO-92 | 2000/Ammo Pack |
| BC557 | TO-92 | 5000 Units/Box |
| BC557ZL1 | TO-92 | 2000/Ammo Pack |
| BC557A | TO-92 | 5000 Units/Box |
| BC557AZL1 | TO-92 | 2000/Ammo Pack |
| BC557B | TO-92 | 5000 Units/Box |
| BC557BRL1 | TO-92 | 2000/Tape & Reel |
| BC557BZL1 | TO-92 | 2000/Ammo Pack |
| BC557C | TO-92 | 5000 Units/Box |
| BC557CZL1 | TO-92 | 2000/Ammo Pack |
| BC558B | TO-92 | 5000 Units/Box |
| BC558BRL | TO-92 | 2000/Tape & Reel |
| BC558BRL1 | TO-92 | 2000/Tape & Reel |
| BC558BZL1 | TO-92 | 2000/Ammo Pack |
| BC558C | TO-92 | 5000 Units/Box |
| BC558CRL1 | TO-92 | 2000/Tape & Reel |
| BC558ZL1 | TO-92 | 2000/Ammo Pack |
| BC558CZL1 | TO-92 | 2000/Ammo Pack |

BC556B, BC557, A, B, C, BC558B, C

Characteristic Symbol Min Тур Max Unit **OFF CHARACTERISTICS** Collector-Emitter Breakdown Voltage V(BR)CEO V BC556 -65 $(I_{C} = -2.0 \text{ mAdc}, I_{B} = 0)$ _ _ BC557 -45 _ _ BC558 -30 _ _ V Collector-Base Breakdown Voltage V(BR)CBO $(I_{C} = -100 \ \mu Adc)$ BC556 -80 _ _ BC557 -50 _ _ BC558 -30 _ _ Emitter-Base Breakdown Voltage V(BR)EBO V BC556 -5.0 $(I_E = -100 \ \mu Adc, I_C = 0)$ _ _ -5.0 BC557 _ _ BC558 -5.0 _ _ Collector–Emitter Leakage Current ICES -100 $(V_{CES} = -40 V)$ BC556 -2.0 nΑ - $(V_{CES} = -20 V)$ -100 BC557 _ -2.0 BC558 _ -2.0 -100 μΑ $(V_{CES} = -20 \text{ V}, \text{ T}_{A} = 125^{\circ}\text{C})$ BC556 _ -4.0 _ BC557 _ _ -4.0 BC558 _ _ -4.0

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

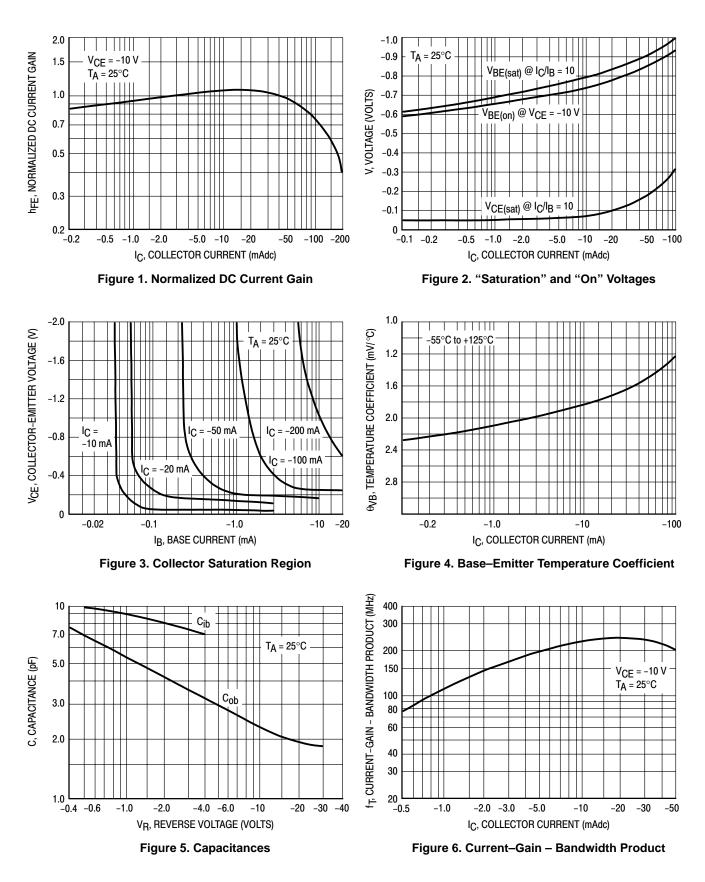
BC556B, BC557, A, B, C, BC558B, C

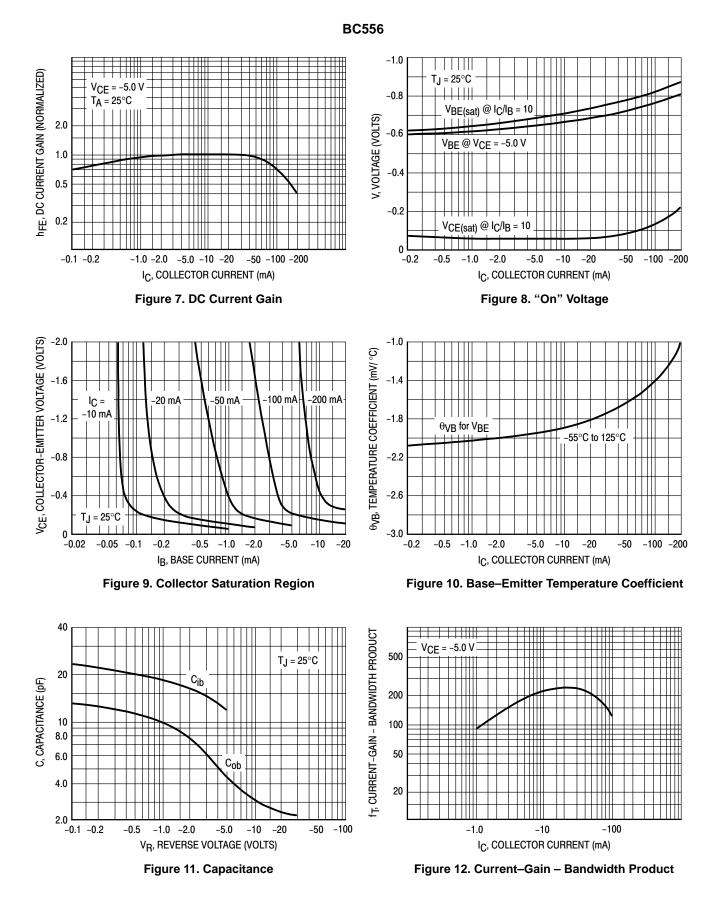
ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|---|--|----------------------|-----------------------------|--|-----------------------------|------|
| ON CHARACTERISTICS | | | | | I | |
| DC Current Gain (I _C = $-10 \ \mu$ Adc, V _{CE} = $-5.0 \ V$) (I _C = $-2.0 \ m$ Adc, V _{CE} = $-5.0 \ V$) | A Series Device B Series Devices C Series Devices BC557 | hFE | - - - 120 | 90 150 270 | - - - 800 | - |
| $(I_{C} = -100 \text{ mAdc}, V_{CE} = -5.0 \text{ V})$ | A Series Device B Series Devices C Series Devices A Series Device B Series Devices C Series Devices | | 120 180 420 - - | 170 290 500 120 180 300 | 220 460 800 - - | |
| Collector–Emitter Saturation Voltage ($I_C = -10 \text{ mAdc}$, $I_B = -0.5 \text{ mAdc}$) ($I_C = -10 \text{ mAdc}$, $I_B = \text{see Note 1}$) ($I_C = -100 \text{ mAdc}$, $I_B = -5.0 \text{ mAdc}$) | | VCE(sat) | - - - | -0.075 -0.3 -0.25 | -0.3 -0.6 -0.65 | V |
| Base–Emitter Saturation Voltage ($I_C = -10 \text{ mAdc}, I_B = -0.5 \text{ mAdc}$) ($I_C = -100 \text{ mAdc}, I_B = -5.0 \text{ mAdc}$) | | V _{BE(sat)} | - | -0.7 -1.0 | - | V |
| Base–Emitter On Voltage ($I_C = -2.0 \text{ mAdc}$, $V_{CE} = -5.0 \text{ Vdc}$) ($I_C = -10 \text{ mAdc}$, $V_{CE} = -5.0 \text{ Vdc}$) | | V _{BE(on)} | -0.55 - | -0.62 -0.7 | -0.7 -0.82 | V |
| SMALL-SIGNAL CHARACTERISTICS | | | | | | |
| Current–Gain – Bandwidth Product ($I_C = -10$ mA, $V_{CE} = -5.0$ V, f = 100 MHz) | BC556 BC557 BC558 | fΤ | - - - | 280 320 360 | - - - | MHz |
| Output Capacitance $(V_{CB} = -10 \text{ V}, I_C = 0, f = 1.0 \text{ MHz})$ | | C _{ob} | - | 3.0 | 6.0 | pF |
| Noise Figure (I _C = -0.2 mAdc, V _{CE} = -5.0 V, R _S = 2.0 k Ω , f = 1.0 kHz, Δ f = 200 Hz) | BC556 BC557 BC558 | NF | | 2.0 2.0 2.0 | 10 10 10 | dB |
| Small–Signal Current Gain (I _C = –2.0 mAdc, V _{CE} = 5.0 V, f = 1.0 kHz) | BC557 A Series Device B Series Devices C Series Devices | h _{fe} | 125 125 240 450 | _ _ _ _ | 900 260 500 900 | - |

Note 1: $I_C = -10$ mAdc on the constant base current characteristics, which yields the point $I_C = -11$ mAdc, $V_{CE} = -1.0$ V.

BC557/BC558





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BC556B, BC557, A, B, C, BC558B, C

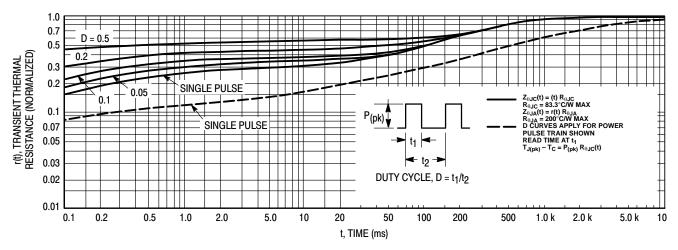


Figure 13. Thermal Response

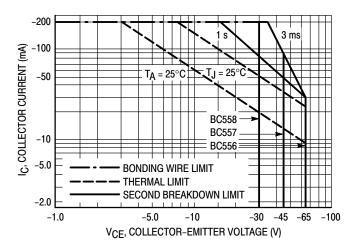


Figure 14. Active Region – Safe Operating Area

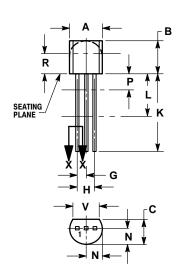
The safe operating area curves indicate I_C-V_{CE} limits of the transistor that must be observed for reliable operation. Collector load lines for specific circuits must fall below the limits indicated by the applicable curve.

The data of Figure 14 is based upon $T_{J(pk)} = 150^{\circ}$ C; T_{C} or T_{A} is variable depending upon conditions. Pulse curves are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}$ C. $T_{J(pk)}$ may be calculated from the data in Figure 13. At high case or ambient temperatures, thermal limitations will reduce the power than can be handled to values less than the limitations imposed by second breakdown.

BC556B, BC557, A, B, C, BC558B, C

PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AL**





NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED. 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

| | INC | HES | MILLIN | IETERS | |
|-----|-------|-------|--------|--------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 0.175 | 0.205 | 4.45 | 5.20 | |
| В | 0.170 | 0.210 | 4.32 | 5.33 | |
| C | 0.125 | 0.165 | 3.18 | 4.19 | |
| D | 0.016 | 0.021 | 0.407 | 0.533 | |
| G | 0.045 | 0.055 | 1.15 | 1.39 | |
| Н | 0.095 | 0.105 | 2.42 | 2.66 | |
| J | 0.015 | 0.020 | 0.39 | 0.50 | |
| Κ | 0.500 | | 12.70 | | |
| L | 0.250 | | 6.35 | | |
| Ν | 0.080 | 0.105 | 2.04 | 2.66 | |
| Ρ | | 0.100 | | 2.54 | |
| R | 0.115 | | 2.93 | | |
| ٧ | 0.135 | | 3.43 | | |

STYLE 17: PIN 1. COLLECTOR 2. BASE 3. EMITTER

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